

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:
Inventor(s): Ju Hyun KIM et al.	:
U.S. Patent Application No. 10/810,634	: Confirmation No.9586
Filed: March 29, 2004	: Group Art Unit: 2823
	: Examiner: FERNANDO L TOLEDO
For: METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-ETCHING	

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450


Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-SB/08A.

This Information Disclosure Statement is being filed under Rule 37 CFR 1.97(i), wherein applicants are submitting references before the grant of a patent to be placed in the file but not considered by the Patent Office. Accordingly, copies of the references as listed on the attached Form PTO-SB/08A are submitted herewith for placement in the file. No certification or fees are deemed necessary.

Respectfully submitted,

**LOWE HAUPTMAN & BERNER, LLP**

  
Benjamin J. Hauptman  
Registration No. 29,310

1700 Diagonal Road, Suite 300  
Alexandria, Virginia 22314  
(703) 684-1111 BJH/ayw  
Facsimile: (703) 518-5499  
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